



## BZT52C2V0T - BZT52C24T

#### SURFACE MOUNT ZENER DIODE

#### **Features**

- Small, Low Profile Surface Mount Package
- Flat Lead Package Design for Low Profile and High Power
  Dissipation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Mechanical Data**

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.001 grams (Approximate)

SOD523



Top View

#### Ordering Information (Note 5)

Part Number (Note 6)	Compliance	Case	Packaging
(Type Number)-7*	Standard	SOD523	3000/Tape & Reel
(Type Number)Q-7*	Automotive	SOD523	3000/Tape & Reel
(Type Number)-13*	Standard	SOD523	10000/Tape & Reel
(Type Number)Q-13*	Automotive	SOD523	10000/Tape & Reel

\*For (Type Number), please see the Electrical Characteristics Table. Example: 6.2V Zener = BZT52C6V2T-7.

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/product\_compliance\_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

6. Dispensed in every other cavity of the tape.

#### **Marking Information**

Notes:



XX = Product Type Marking Code (See Electrical Characteristics Table)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current t	by 20%.			
Characte	eristic	Symbol	Value	Unit
Forward Voltage	@ I <sub>F</sub> = 10mA	VF	0.9	V

## **Thermal Characteristics**

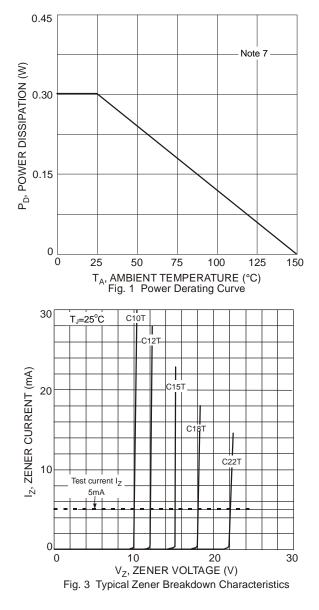
Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 7)	PD	300	mW	
Thermal Resistance, Junction to Ambient Air (Note 7)	R <sub>0JA</sub>	417	°C/W	
Thermal Resistance, Junction to Case (Note 7)	R <sub>θJC</sub>	160	°C/W	
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C	

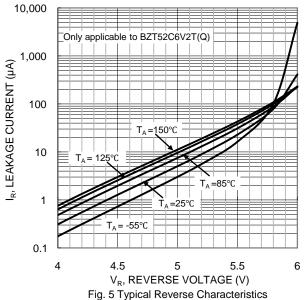
Type Marking Number Codes	Marking Codes	Zener Voltage Range (Note 8)			Maximum Zener Impedance f = 1kHz		Maximum Reverse Current (Note 8)		Temperature Coefficient @ I <sub>ZT</sub> mV/°C			
		Vz @ Izt		Izt	Z <sub>ZT</sub> @ I <sub>ZT</sub> Z <sub>ZK</sub> @ I <sub>ZK</sub>		Izĸ	IR	@ V <sub>R</sub>			
		Nom (V)	Min (V)	Max (V)	mA	9	2	mA	μA	V	Min	Мах
BZT52C2V0T	WY	2.0	1.91	2.09	5	100	600	1.0	150	1.0	-3.5	0
BZT52C2V4T	WX	2.4	2.2	2.6	5	100	600	1.0	50	1.0	-3.5	0
BZT52C2V7T	W1	2.7	2.5	2.9	5	100	600	1.0	20	1.0	-3.5	0
BZT52C3V0T	W2	3.0	2.8	3.2	5	95	600	1.0	10	1.0	-3.5	0
BZT52C3V3T	W3	3.3	3.1	3.5	5	95	600	1.0	5.0	1.0	-3.5	0
BZT52C3V6T	W4	3.6	3.4	3.8	5	90	600	1.0	5.0	1.0	-3.5	0
BZT52C3V9T	W5	3.9	3.7	4.1	5	90	600	1.0	3.0	1.0	-3.5	0
BZT52C4V3T	W6	4.3	4.0	4.6	5	90	600	1.0	3.0	1.0	-3.5	0
BZT52C4V7T	W7	4.7	4.4	5.0	5	80	500	1.0	3.0	2.0	-3.5	0.2
BZT52C5V1T	W8	5.1	4.8	5.4	5	60	480	1.0	2.0	2.0	-2.7	1.2
BZT52C5V6T	<u>W</u> 9	5.6	5.2	6.0	5	40	400	1.0	1.0	2.0	-2	2.5
BZT52C6V2T	<u>W</u> A	6.2	5.8	6.6	5	10	150	1.0	3.0	4.0	0.4	3.7
BZT52C6V8T	<u>W</u> B	6.8	6.4	7.2	5	15	80	1.0	2.0	4.0	1.2	4.5
BZT52C7V5T	<u>W</u> C	7.5	7.0	7.9	5	15	80	1.0	1.0	5.0	2.5	5.3
BZT52C8V2T	<u>W</u> D	8.2	7.7	8.7	5	15	80	1.0	0.7	5.0	3.2	6.2
BZT52C9V1T	<u>W</u> E	9.1	8.5	9.6	5	15	100	1.0	0.5	6.0	3.8	7.0
BZT52C10T	<u>W</u> F	10	9.4	10.6	5	20	150	1.0	0.2	7.0	4.5	8.0
BZT52C11T	<u>W</u> G	11	10.4	11.6	5	20	150	1.0	0.1	8.0	5.4	9.0
BZT52C12T	<u>W</u> H	12	11.4	12.7	5	25	150	1.0	0.1	8.0	6.0	10.0
BZT52C13T	WI	13	12.4	14.1	5	30	170	1.0	0.1	8.0	7.0	11.0
BZT52C15T	<u>W</u> J	15	13.8	15.6	5	30	200	1.0	0.1	10.5	9.2	13.0
BZT52C16T	<u>W</u> K	16	15.3	17.1	5	40	200	1.0	0.1	11.2	10.4	14.0
BZT52C18T	WL	18	16.8	19.1	5	45	225	1.0	0.1	12.6	12.4	16.0
BZT52C20T	WM	20	18.8	21.2	5	55	225	1.0	0.1	14.0	14.4	18.0
BZT52C22T	WN	22	20.8	23.3	5	55	250	1.0	0.1	15.4	16.4	20.0
BZT52C24T	WO	24	22.8	25.6	5	70	250	1.0	0.1	16.8	18.4	22.0

#### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Notes: 7. Part mounted on FR-4 PC board, single-sided, 2oz. copper with pad areas 1.92mm<sup>2</sup>. 8. Short duration pulse test used to minimize self-heating effect.







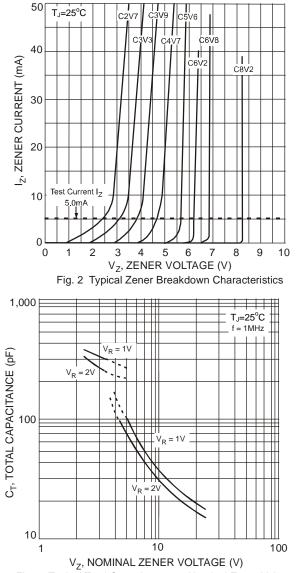


Fig. 4 Typical Total Capacitance vs. Nominal Zener Voltage

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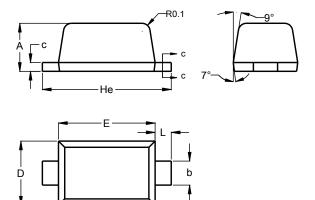


#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOD523

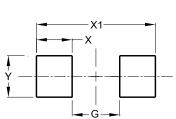
SOD523



SOD523					
Dim	Min	Max			
Α	0.55	0.65			
b	0.26	0.34			
С	0.11	0.17			
D	0.75	0.85			
E	1.15	1.25			
He	He 1.55 1.65				
L	0.10	0.30			
All Dimensions in mm					

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Y	0.70

BZT52C2V0T - BZT52C24T Document number: DS30502 Rev. 14 - 2



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